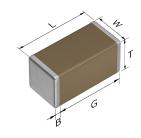


## 积层贴片陶瓷片式电容器

C3216X7T2J153M085AC

RoHS Reach Halogen Free Pb Free

交货型号	C3216X7T2J153MT****
用途	一般等级
特点	Mid 中耐压(100~630V)
系列	C3216 [EIA 1206]
状态	▲ 量产体制(新设计非推荐)



尺寸			
长度(L)	$3.20 \text{mm} \pm 0.20 \text{mm}$		
宽度(W)	$1.60$ mm $\pm 0.20$ mm		
厚度(T)	0.85mm ±0.15mm		
端子宽度(B)	0.20mm Min.		
端子间隔(G)	1.00mm Min.		
推荐焊盘布局(PA)	2.10mm to 2.50mm(Flow Soldering)		
1世存产益4月/月 (FA)	2.00mm to 2.40mm(Reflow Soldering)		
推荐焊盘布局(PB)	1.10mm to 1.30mm(Flow Soldering)		
TE存斥血和内(ID)	1.00mm to 1.20mm(Reflow Soldering)		
推荐焊盘布局(PC)	1.00mm to 1.30mm(Flow Soldering)		
TEAT/YETTOPH (I O)	1.10mm to 1.60mm(Reflow Soldering)		

电气特性		
电容	15nF ±20%	
额定电压	630VDC	
温度特性	X7T (+22, -33%)	
耗散因数(Max.)	2.5%	
绝缘电阻 (Min.)	10000ΜΩ	

	其他	
焊接方法	流体	
<b>坪</b> 接刀法	回流	
AEC-Q200	NO NO	
包装形式	纸编带 (180mm卷筒)	
包装个数	4000pcs	

<sup>!</sup> Images are for reference only and show exemplary products.

<sup>!</sup> This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.



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特性图表(这是参考数据,并不保证产品的特性。)

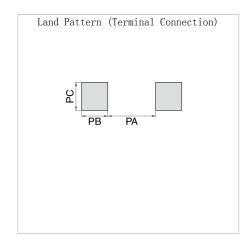
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## Associated Images



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